

06-20-2007

FLH Ref. No.: 450137-05968

6/18/07



U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

To the Honorable Commissioner

103418156

Attached original documents or copy thereof.

1. Name of conveying parties

Toshiyuki HIROI, Akihiko SUGAWARA

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Sony Computer Entertainment Inc.
2-6-21, Minami-Aoyama, Minato-ku
Tokyo 107-0062
Japan

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment
- Security Agreement
- Merger
- Change of Name
- Other

Execution Date(s): June 1, 2007

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No. 11/728,542 filed March 26, 2007.

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: WILLIAM S. FROMMER
Internal Address: FROMMER LAWRENCE & HAUG LLP
Street Address: 745 FIFTH AVENUE
City: NEW YORK State: NY Zip: 10151

6. Total number of applications and patents involved

1

7. Total fee (37 CFR 3.41)

\$ 40.00

- Enclosed
- Authorized to be charged to deposit account 50-0320

8. Deposit account number:

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Paul A. Levy, Reg. No. 45,748

June 14, 2007

Name of Person Signing

Signature

Date

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00457259

PATENT
REEL: 019460 FRAME: 0020

ASSIGNMENT

WHEREAS, I, as below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

PROCESSING APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY COMPUTER ENTERTAINMENT INC., a Japanese Corporation, with offices at 2-6-21, Minami-Aoyama, Minato-ku, Tokyo, 107-0062, Japan (hereinafter referred to as ASSIGNEES) are desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/728,542, Filing Date: March 26, 2007.

This assignment executed on the dates indicated below.

Toshiyuki HIROI

Name of sole or 1st inventor _____ Execution date of U.S. Patent Application _____

Saitama, Japan

Residence of sole or 1st inventor _____

Toshiyuki Hiroi

June 1, 2007

Signature of sole or 1st inventor _____ Date of this assignment _____

Akihiko SUGAWARA

Name of 2nd joint inventor _____ Execution date of U.S. Patent Application _____

Kanagawa, Japan

Residence of 2nd joint inventor _____

Akihiko Sugawara

June 1, 2007

Signature of 2nd joint inventor _____ Date of this assignment _____

00446814

PATENT**RECORDED: 06/18/2007****REEL: 019460 FRAME: 0021**